## I. SCOPE:

This specification applies to the Pb Free high current type SMD inductors for MSI-100807-SERIES

#### PRODUCT INDENTIFICATION

<u>MSI - 100807 - R12 M</u>

1 2 3 4

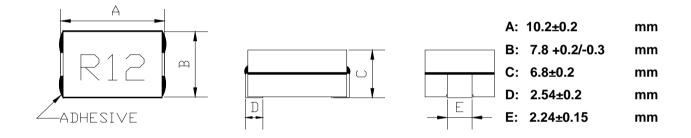
① Product Code

② Dimensions Code

③ Inductance Code

④ Tolerance Code

## (1) SHAPES AND DIMENSIONS



## (2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

**TEST INSTRUMENTS** 

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

IDC1 :WK3255B+3265B (or equivalent)

## (3) CHARACTERISTICS

(3)-1 Operate temperature range ......  $-40^\circ$ C  $\sim +125^\circ$ C (Including self temp. rise)

(3)-2 Storage temperature range ......  $-40^\circ\!\!C\!\sim\!+125^\circ\!\!C$ 



#### TABLE

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current		Marking
PT/NO.	L(µH)	Tolerance	Frequency	RDC(mΩ)	IDC1(A)	IDC2(A)	Warking
MSI-100807-R12	0.12	K,L,M	100kHz/0.1V	0.29±7%	80	54	R12
MSI-100807-R14	0.14	K,L,M	100kHz/0.1V	0.29±7%	72	54	R14
MSI-100807-R15	0.15	K,L,M	100kHz/0.1V	0.29±7%	70	54	R15
MSI-100807-R17	0.17	K,L,M	100kHz/0.1V	0.29±7%	58	54	R17
MSI-100807-R18	0.18	K,L,M	100kHz/0.1V	0.29±7%	56	54	R18
MSI-100807-R215	0.215	K,L,M	100kHz/0.1V	0.29±7%	50	54	R215
MSI-100807-R22	0.22	K,L,M	100kHz/0.1V	0.29±7%	50	54	R22
MSI-100807-R30	0.30	K,L,M	100kHz/0.1V	0.29±7%	32	54	R30

% □ specify the inductance tolerance,L(±15%),M(±20%)

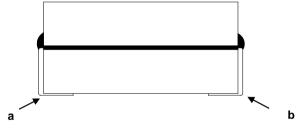
IDC1 : Based on inductance change ( $\Delta$ L/Lo : drop 20% Typ.)@ ambient temp. 25 $^{\circ}$ C

IDC2 : Based on temperature rise ( $\triangle T$  : 40°C TYP.)

Rated DC Current: The less value which is IDC1 or IDC2 .

#### **RDC TEST POINT**

The nominal DCR is measured from point "a" to point "b" .





# (4) RELIABILITY TEST METHOD

## MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS		
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		in figure 1 and a load applied unitil the figure in the arrow		
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)		
	no mechanical	PCB dimension shall the page 7/9		
	damage or elec-	F(Pressurization)		
	trical damege.			
		R5 45±2 45±2 10 R340		
		PRESSURE ROD figure-1		
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		and when a vibration having an amplitude of 1.52mm		
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should		
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.		
	damage.	(A total of 6 hours)		
	New solder	Flux (regin isopropul clocks) ( US K (1522)) shall be costed		
Solderability	More than 90%	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall		
		then be preheated for about 2 minutes in a temperature of		
		130 $\sim$ 150°C and after it has been immersed to a depth 0.5mm		
		below for $3\pm0.2$ seconds fully in molten solder M705 with		
		a temperature of 245±5℃.		
		More than 90% of the electrode sections shall be couered		
		with new solder smoothly when the sample is taken out of		
		the solder bath.		



## MECHANICAL

TEST ITEM	SPECIFICATION					
Resistance to	There shall be	Temperature profile of reflow soldering				
Soldering heat	no damage or					
(reflow soldering)	problems.	$\begin{array}{c} \begin{array}{c} \begin{array}{c} 0\\ 0\\ 250\\ 200\\ 150\\ 100\\ 50\\ \end{array} \end{array} \begin{array}{c} \end{array} \\ \begin{array}{c} Pre-heating\\ 100\\ 50\\ \end{array} \end{array} \begin{array}{c} Pre-heating\\ 150 \sim 180^{\circ}C\\ \end{array} \end{array} \begin{array}{c} \end{array} \\ \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$				

#### ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Temperature	<b>∆L/L20℃≦±10%</b>	The test shall be performed after the sample has stabilized in			
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\mathrm{C}$ ,and the value			
		calculated based on the value applicable in a normal			
		temperature and narmal humidity shall be $ riangle L/L20^\circ\!C \leq \pm 10\%$ .			



## **ENVIROMENT CHARACTERISTICS**

TEST ITEM				SPECIFICATION			
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with					
storage		a tempe	a temperature of 125 $^{ m \circ}{ m C}$ and a normal humidity.				
	There shall be	Upon co	Upon completion of the measurement shall be made after the				
	no mechanical	sample	sample has been left in a normal temperature and normal				
	damage.	humidit	humidity for 1 hour.				
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a tempe	a temperature of -25±3℃.				
	There shall be	Upon co	Upon completion of the test, the measurement shall be made				
	no mechanical	after the	after the sample has been left in a normal temperature and				
	damage.	normal	normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the ta	in the table 2 below and then it shall be subjected to standard				
	There shall be	stmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be made.					
	ge of problems						
			table 2				
				Temperature	Duration		
			1	<b>−25±3°</b> C	30 min.		
				(Themostat No.1)	30 min.		
			2	Standard	No.1→No.2		
			_	atmospheric			
			3	<b>85±2℃</b>	30 min.		
			Ĺ	(Themostat No.2)	<b>50</b> mm.		
			4	Standard	No.2→No.1		
				atmospheric	N0.2→N0.1		
Moisture storage	∆L/Lo≦±5%	The san	nnles	hall be left for 96+4 bou	rs in a temperature of	:	
Moisture storage		The sample shall be left for 96±4 hours in a temperature of 40±2℃ and a humidity(RH) of 90~95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and					
		normal humidity more than 1 hour.					
	damage.	normal	numi	any more man't nour.			

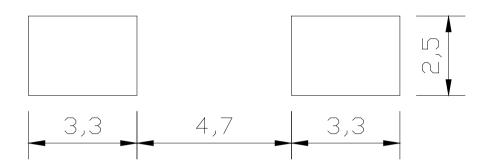


## (5) LAND DIMENSION (Ref.)

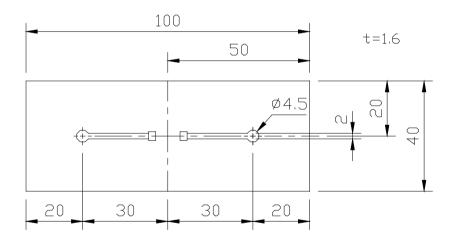
PCB: GLASS EPOXY t=1.6mm

#### (5)-1 LAND PATTERN DIMENSIONS(mm)

(STANDARD PATTERN)

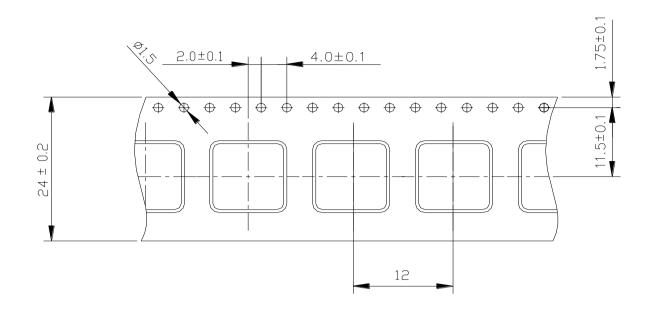


### (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

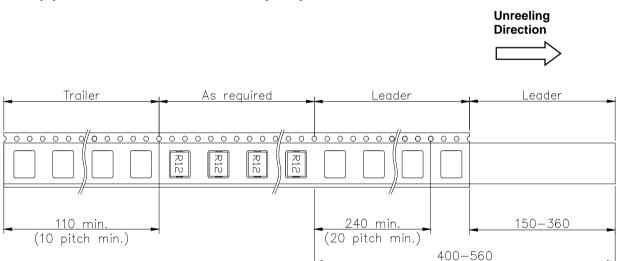




## (6) PACKAGING (6)-1 CARRIER TAPE DIMENSIONS (mm)

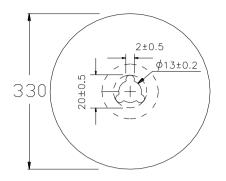


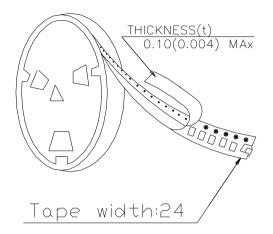
## (6)-2 TAPING DIMENSIONS (mm)





## (6)-3 REEL DIMENSIONS (mm)





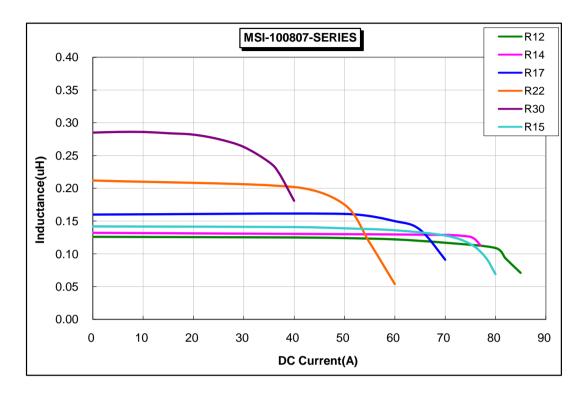
### (6)-4 QUANTITY

#### 500pcs/Reel

The products are packaged so that no damage will be sustained.

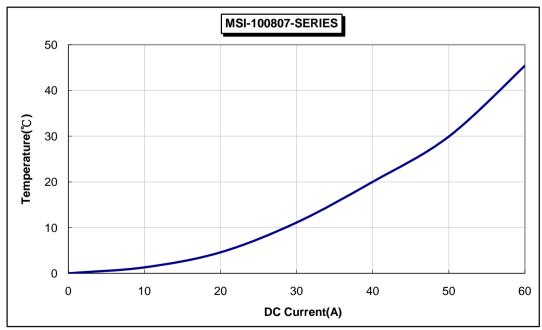


### **TYPICAL ELECTRICAL CHARACTERISTICS**



### INDUCTANCE vs. DC CURRENT@100kHz/0.1V Ambient Temperature : $25^{\circ}$ C

# Temperature Rise vs. DC Current





MSI-100807-SERIES